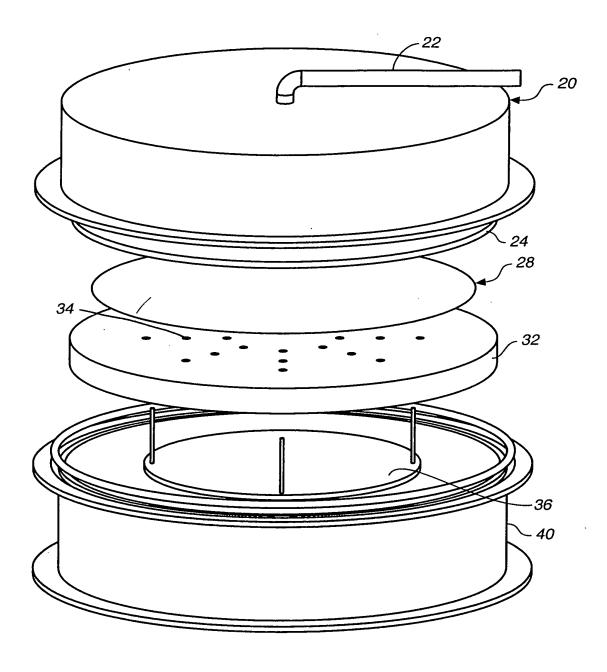


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**FIG.\_1** (PRIOR ART)

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